

#### Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com





RJ45 transmitter sockets (magnetics) for gigabit applications (1000 base-T) with integrated compensation actively counteracts inductive and capacitive couplings and saves space on the PCB.

The product range encompasses the following designs:

- 90°, lying (horizontal) and 180°, standing (vertical)
- latch up / latch down
- THT, THR or SMD soldering processes
- Wide range of different design types, also with
- integrated LEDs and shield contact tabs
- Transmission rates of up to 1 Gbps
- Packed either in a tray (TY) or on a roll (tape-on-reel, RL)
- Compatible with modular RJ45 connector according to ANSI / TIA-1096-A and IEC 60603
- Dielectric strength ≥1500 V AC RMS (2250 V AC peak value) according to IEEE 802.3
- Dielectric strength ≥1500 V AC (peak value) or ≥1500 V DC according to IEC 60603
- Compliance with IEEE 802.3 requirements (1000Base-

T, 1 Gbps, IEEE 802.3ab or 100Base-Tx, 100 Mbps, IEEE 802.3u)

Properties and advantages:

- Extended temperature range of -40 °C to +85 °C for maximum performance
- Reinforced gold layer (30µ") for improved corrosion protection

• At least 0.3mm stand-off ensures a perfect soldering result

#### **General ordering data**

Version	PCB plug-in connector, RJ45 jacks transformer, 10/100 MBit/s , THT/THR solder connection, 180°, Shield tabs: none, 3080 $\mu$ " Ni / ≥ 30 $\mu$ " Au , LED: Yes, yellow, green, Number of poles: 8, Tray (manual assembly)
Order No.	<u>2461070000</u>
Туре	RJ45M R1V 3.3N4Y/G TY
GTIN (EAN)	4050118476071
Qty.	120 pc(s).
Packaging	Tray (manual assembly)



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# **Technical data**

#### **Dimensions and weights**

Depth	16.8 mm	Depth (inches)	0.661 inch
Height	20.3 mm	Height (inches)	0.799 inch
Height of lowest version	17 mm	Width	16 mm
Width (inches)	0.63 inch	Net weight	3.658 g

## System specifications

Colour of left LED	yellow	Colour of right LED	green
LED		Mounting onto the PCB	THT/THR solder
	Yes		connection
Number of poles	8	Number of solder pins per pole	1
Outgoing elbow	180°	Performance-Category	10/100 MBit/s
Pitch in inches (P)	0.05 inch	Pitch in mm (P)	1.27 mm
Plugging cycles		Product family	OMNIMATE Data - RJ45
	750		transformer jack
Protection degree	IP20	Shield surface	nickel-plated
Shield tabs	none	Shielding	Yes
Shielding material	Brass	Solder eyelet hole diameter (D)	0.9 mm
Solder eyelet hole diameter to	lerance (D)± 0.1 mm	Solder pin length (I)	3.3 mm
Soldering process	Reflow soldering, Manual	Tolerance of solder pin position	
	soldering, Wave soldering		± 0.1 mm
Transmission rate	10/100 MBit/s	Type of connection	Solder connection

## **Electrical properties**

Dielectric strength, contact / contact	1000 V DC	Dielectric strength, contact / shield	1500 V DC
Rated current	1.5 A	Rated voltage	125 V

#### **Material data**

Insulating material	PA 9T	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	II
Comparative Tracking Index (CTI)	≥ 500	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact base material	Phosphorus bronze
Contact material	Phosphorus bronze	Contact surface	Gold over nickel
Layer structure of plug contact	3080 µ" Ni / ≥ 30 µ" Au	Storage temperature, min.	-40 °C
Storage temperature, max.	85 °C	Operating temperature, min.	-40 °C
Operating temperature, max.	85 °C		

#### Packing

Packaging	Tray (manual assembly)	VPE length	315 mm
VPE width	190 mm	VPE height	69 mm

## Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ECLASS 9.0	27-44-04-02
ECLASS 9.1	27-44-04-02	ECLASS 10.0	27-44-04-02
ECLASS 11.0	27-46-02-01	ECLASS 12.0	27-46-02-01



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# **Technical data**

#### Approvals

Approvals



ROHS	Conform	
Certificate No. (UL)	E471884	
Certificate No. (cURus)	E471884	

#### Downloads

Approval/Certificate/Document of	
Conformity	Certificate of Compliance
Engineering Data	CAD data – STEP
Product Change Notification	PCN
	PCN
User Documentation	MAN IE GUIDE DE
	MAN IE GUIDE EN
Catalogues	Catalogues in PDF-format



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# Drawings

## **Dimensioned drawing**





## **Dimensional drawing**



## **Dimensional drawing**

**Dimensional drawing** 



## **Dimensional drawing**



## **Dimensional drawing**





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Drawings

## PCB design



PCB LAYOUT

## Wiring diagram





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# Drawings

Packaging	TY RL	Tray in box (manual assembly) Tape on Reel (automated assembly)
LED	Y/G G/Y GY/GY O/G R/O  N	Yellow/Green Green/Yellow (standard) Green/Yellow/Green Yellow Orange/Green Red/Orange (further combinations possible) without LED
Contact surface thickness	4	$1 = 3\mu^{*}, 2 = 6\mu^{*}, 3 = 15\mu^{*}, 4 = 30\mu^{*}, 5 = 50\mu$
EMI tabs (ground fingers)	E N	E = with EMI tabs N = without EMI tabs
Solder Pin length	3.2 1.6 D	3.2 mm 1.6 mm SM <b>D</b>
Direction, latch style	U D V Y	Horizontal (90°, side entry), latch up Horizontal (90°, side entry), latch down Vertical (180°, top entry) Diagonal (45°), latch up
Number of Ports	1 12; 14; 21; 41;	1 Port multi ports side by side, Multiport multi ports about each other, Multilevel
Assembly on PCB	R S	Through Hole Reflow - THR Soldering process: Wave or Reflow soldering Surface Mount Technology - SMT Soldering process: Reflow soldering
	т	Through Hole Technology - TH <b>T</b> Soldering process: Wave
Performance Category	C5 C6 C6A C5e	Category 5 Category 6 Category 6A Category 5e
	M G1 G10 U	10/100 Mbit 10/100/1000 Mbit 10 Gbit Unshielded
	MP MP+	10/100 Mbit with POE 10/100 Mbit with POE+

# RJ45 G1 R 1 U 3.2 E 4 GY/GY TY RJ45G1 R1U 3.2E4GY/GY TY

Type codes

# **Recommended wave solderding profiles**



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### **Double Wave:**



### Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

# **Recommended reflow soldering profile**



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Time [sec]

### **Reflow soldering profile**

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- · Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically  $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at  $\geq$  -6K/s solder is cured. Board and components cool down while avoiding cold cracks.